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# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

# **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	72
Number of Logic Elements/Cells	576
Total RAM Bits	12288
Number of I/O	66
Number of Gates	56000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep1k10tc100-1

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



For more information on the configuration of ACEX 1K devices, see the following documents:

- Configuration Devices for ACEX, APEX, FLEX, & Mercury Devices Data Sheet
- MasterBlaster Serial/USB Communications Cable Data Sheet
- ByteBlasterMV Parallel Port Download Cable Data Sheet
- BitBlaster Serial Download Cable Data Sheet

ACEX 1K devices are supported by Altera development systems, which are integrated packages that offer schematic, text (including AHDL), and waveform design entry, compilation and logic synthesis, full simulation and worst-case timing analysis, and device configuration. The software provides EDIF 2 0 0 and 3 0 0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools.

The Altera software works easily with common gate array EDA tools for synthesis and simulation. For example, the Altera software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the Altera software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the Altera development system includes DesignWare functions that are optimized for the ACEX 1K device architecture.

The Altera development systems run on Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations.



For more information, see the MAX+PLUS II Programmable Logic Development System & Software Data Sheet and the Quartus Programmable Logic Development System & Software Data Sheet.

# Functional Description

Each ACEX 1K device contains an enhanced embedded array that implements memory and specialized logic functions, and a logic array that implements general logic.

The embedded array consists of a series of EABs. When implementing memory functions, each EAB provides 4,096 bits, which can be used to create RAM, ROM, dual-port RAM, or first-in first-out (FIFO) functions. When implementing logic, each EAB can contribute 100 to 600 gates towards complex logic functions such as multipliers, microcontrollers, state machines, and DSP functions. EABs can be used independently, or multiple EABs can be combined to implement larger functions.

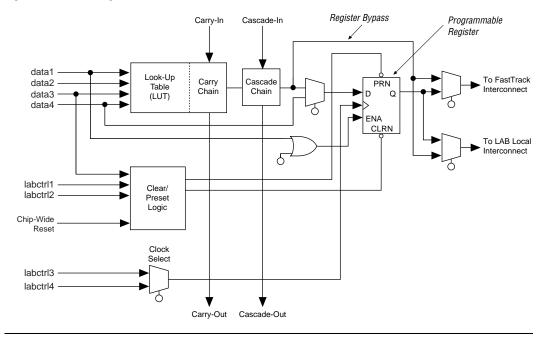
The logic array consists of logic array blocks (LABs). Each LAB contains eight LEs and a local interconnect. An LE consists of a 4-input LUT, a programmable flipflop, and dedicated signal paths for carry and cascade functions. The eight LEs can be used to create medium-sized blocks of logic—such as 8-bit counters, address decoders, or state machines—or combined across LABs to create larger logic blocks. Each LAB represents about 96 usable logic gates.

Signal interconnections within ACEX 1K devices (as well as to and from device pins) are provided by the FastTrack Interconnect routing structure, which is a series of fast, continuous row and column channels that run the entire length and width of the device.

Each I/O pin is fed by an I/O element (IOE) located at the end of each row and column of the FastTrack Interconnect routing structure. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an output or input register to feed input, output, or bidirectional signals. When used with a dedicated clock pin, these registers provide exceptional performance. As inputs, they provide setup times as low as 1.1 ns and hold times of 0 ns. As outputs, these registers provide clock-to-output times as low as 2.5 ns. IOEs provide a variety of features, such as JTAG BST support, slew-rate control, tri-state buffers, and open-drain outputs.

Figure 1 shows a block diagram of the ACEX 1K device architecture. Each group of LEs is combined into an LAB; groups of LABs are arranged into rows and columns. Each row also contains a single EAB. The LABs and EABs are interconnected by the FastTrack Interconnect routing structure. IOEs are located at the end of each row and column of the FastTrack Interconnect routing structure.

Figure 8. ACEX 1K Logic Element



The programmable flipflop in the LE can be configured for D, T, JK, or SR operation. The clock, clear, and preset control signals on the flipflop can be driven by global signals, general-purpose I/O pins, or any internal logic. For combinatorial functions, the flipflop is bypassed and the LUT's output drives the LE's output.

The LE has two outputs that drive the interconnect: one drives the local interconnect, and the other drives either the row or column FastTrack Interconnect routing structure. The two outputs can be controlled independently. For example, the LUT can drive one output while the register drives the other output. This feature, called register packing, can improve LE utilization because the register and the LUT can be used for unrelated functions.

The ACEX 1K architecture provides two types of dedicated high-speed data paths that connect adjacent LEs without using local interconnect paths: carry chains and cascade chains. The carry chain supports high-speed counters and adders, and the cascade chain implements wide-input functions with minimum delay. Carry and cascade chains connect all LEs in a LAB and all LABs in the same row. Intensive use of carry and cascade chains can reduce routing flexibility. Therefore, the use of these chains should be limited to speed-critical portions of a design.

## Carry Chain

The carry chain provides a very fast (as low as 0.2 ns) carry-forward function between LEs. The carry-in signal from a lower-order bit drives forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the ACEX 1K architecture to efficiently implement high-speed counters, adders, and comparators of arbitrary width. Carry chain logic can be created automatically by the compiler during design processing, or manually by the designer during design entry. Parameterized functions, such as LPM and DesignWare functions, automatically take advantage of carry chains.

Carry chains longer than eight LEs are automatically implemented by linking LABs together. For enhanced fitting, a long carry chain skips alternate LABs in a row. A carry chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from odd-numbered LAB to odd-numbered LAB. For example, the last LE of the first LAB in a row carries to the first LE of the third LAB in the row. The carry chain does not cross the EAB at the middle of the row. For instance, in the EP1K50 device, the carry chain stops at the eighteenth LAB, and a new carry chain begins at the nineteenth LAB.

Figure 9 shows how an n-bit full adder can be implemented in n+1 LEs with the carry chain. One portion of the LUT generates the sum of two bits using the input signals and the carry-in signal; the sum is routed to the output of the LE. The register can be bypassed for simple adders or used for an accumulator function. Another portion of the LUT and the carry chain logic generates the carry-out signal, which is routed directly to the carry-in signal of the next-higher-order bit. The final carry-out signal is routed to an LE, where it can be used as a general-purpose signal.

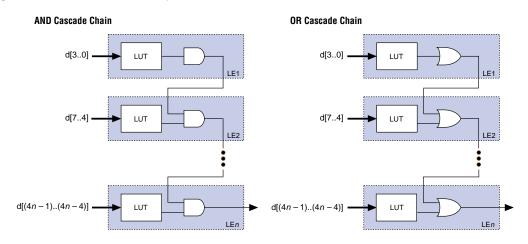
#### Cascade Chain

With the cascade chain, the ACEX 1K architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical  ${\tt AND}$  or logical  ${\tt OR}$  (via De Morgan's inversion) to connect the outputs of adjacent LEs. With a delay as low as 0.6 ns per LE, each additional LE provides four more inputs to the effective width of a function. Cascade chain logic can be created automatically by the compiler during design processing, or manually by the designer during design entry.

Cascade chains longer than eight bits are implemented automatically by linking several LABs together. For easier routing, a long cascade chain skips every other LAB in a row. A cascade chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from odd-numbered LAB to odd-numbered LAB (e.g., the last LE of the first LAB in a row cascades to the first LE of the third LAB). The cascade chain does not cross the center of the row (e.g., in the EP1K50 device, the cascade chain stops at the eighteenth LAB, and a new one begins at the nineteenth LAB). This break is due to the EAB's placement in the middle of the row.

Figure 10 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. The LE delay is 1.3 ns; the cascade chain delay is 0.6 ns. With the cascade chain, decoding a 16-bit address requires 3.1 ns.

Figure 10. ACEX 1K Cascade Chain Operation



#### Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a 4-input LUT. The compiler automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. Either the register or the LUT can be used to drive both the local interconnect and the FastTrack Interconnect routing structure at the same time.

The LUT and the register in the LE can be used independently (register packing). To support register packing, the LE has two outputs; one drives the local interconnect, and the other drives the FastTrack Interconnect routing structure. The DATA4 signal can drive the register directly, allowing the LUT to compute a function that is independent of the registered signal; a 3-input function can be computed in the LUT, and a fourth independent signal can be registered. Alternatively, a 4-input function can be generated, and one of the inputs to this function can be used to drive the register. The register in a packed LE can still use the clock enable, clear, and preset signals in the LE. In a packed LE, the register can drive the FastTrack Interconnect routing structure while the LUT drives the local interconnect, or vice versa.

#### Arithmetic Mode

The arithmetic mode offers two 3-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT computes a 3-input function; the other generates a carry output. As shown in Figure 11, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three signals: a, b, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain.

### **Up/Down Counter Mode**

The up/down counter mode offers counter enable, clock enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Two 3-input LUTs are used; one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals without using the LUT resources.

# FastTrack Interconnect Routing Structure

In the ACEX 1K architecture, connections between LEs, EABs, and device I/O pins are provided by the FastTrack Interconnect routing structure, which is a series of continuous horizontal and vertical routing channels that traverse the device. This global routing structure provides predictable performance, even in complex designs. In contrast, the segmented routing in FPGAs requires switch matrices to connect a variable number of routing paths, increasing the delays between logic resources and reducing performance.

The FastTrack Interconnect routing structure consists of row and column interconnect channels that span the entire device. Each row of LABs is served by a dedicated row interconnect. The row interconnect can drive I/O pins and feed other LABs in the row. The column interconnect routes signals between rows and can drive I/O pins.

Row channels drive into the LAB or EAB local interconnect. The row signal is buffered at every LAB or EAB to reduce the effect of fan-out on delay. A row channel can be driven by an LE or by one of three column channels. These four signals feed dual 4-to-1 multiplexers that connect to two specific row channels. These multiplexers, which are connected to each LE, allow column channels to drive row channels even when all eight LEs in a LAB drive the row interconnect.

Each column of LABs or EABs is served by a dedicated column interconnect. The column interconnect that serves the EABs has twice as many channels as other column interconnects. The column interconnect can then drive I/O pins or another row's interconnect to route the signals to other LABs or EABs in the device. A signal from the column interconnect, which can be either the output of a LE or an input from an I/O pin, must be routed to the row interconnect before it can enter a LAB or EAB. Each row channel that is driven by an IOE or EAB can drive one specific column channel.

Access to row and column channels can be switched between LEs in adjacent pairs of LABs. For example, a LE in one LAB can drive the row and column channels normally driven by a particular LE in the adjacent LAB in the same row, and vice versa. This flexibility enables routing resources to be used more efficiently. Figure 13 shows the ACEX 1K LAB.

When dedicated inputs drive non-inverted and inverted peripheral clears, clock enables, and output enables, two signals on the peripheral control bus will be used.

Table 7 lists the sources for each peripheral control signal and shows how the output enable, clock enable, clock, and clear signals share 12 peripheral control signals. Table 7 also shows the rows that can drive global signals.

Table 7. Peripheral Bus Sources	for ACEX Devices			
Peripheral Control Signal	EP1K10	EP1K30	EP1K50	EP1K100
OE0	Row A	Row A	Row A	Row A
OE1	Row A	Row B	Row B	Row C
OE2	Row B	Row C	Row D	Row E
OE3	Row B	Row D	Row F	Row L
OE4	Row C	Row E	Row H	Row I
OE5	Row C	Row F	Row J	Row K
CLKENAO/CLKO/GLOBALO	Row A	Row A	Row A	Row F
CLKENA1/OE6/GLOBAL1	Row A	Row B	Row C	Row D
CLKENA2/CLR0	Row B	Row C	Row E	Row B
CLKENA3/OE7/GLOBAL2	Row B	Row D	Row G	Row H
CLKENA4/CLR1	Row C	Row E	Row I	Row J
CLKENA5/CLK1/GLOBAL3	Row C	Row F	Row J	Row G

Signals on the peripheral control bus can also drive the four global signals, referred to as <code>GLOBALO</code> through <code>GLOBALO</code>. An internally generated signal can drive a global signal, providing the same low-skew, low-delay characteristics as a signal driven by an input pin. An LE drives the global signal by driving a row line that drives the peripheral bus which then drives the global signal. This feature is ideal for internally generated clear or clock signals with high fan-out. However, internally driven global signals offer no advantage over the general-purpose interconnect for routing data signals.

The chip-wide output enable pin is an active-high pin that can be used to tri-state all pins on the device. This option can be set in the Altera software. The built-in I/O pin pull-up resistors (which are active during configuration) are active when the chip-wide output enable pin is asserted. The registers in the IOE can also be reset by the chip-wide reset pin.

### Column-to-IOE Connections

When an IOE is used as an input, it can drive up to two separate column channels. When an IOE is used as an output, the signal is driven by a multiplexer that selects a signal from the column channels. Two IOEs connect to each side of the column channels. Each IOE can be driven by column channels via a multiplexer. The set of column channels is different for each IOE (see Figure 17).

Each IOE is driven by a m-to-1 multiplexer

Column Interconnect

Figure 17. ACEX 1K Column-to-IOE Connections Note (1)

# Note:

The values for m and n are shown in Table 9.

Table 9 lists the ACEX 1K column-to-IOE interconnect resources.

Each IOE can drive two column channels.

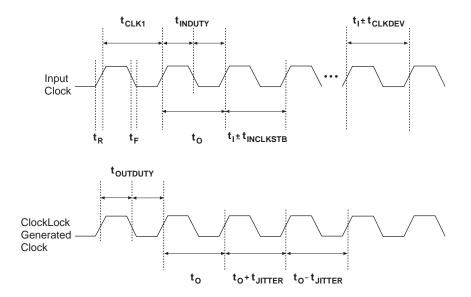
Table 9. ACEX 1K	Table 9. ACEX 1K Column-to-IOE Interconnect Resources							
Device	Channels per Column (n)	Column Channels per Pin (m)						
EP1K10	24	16						
EP1K30	24	16						
EP1K50	24	16						
EP1K100	24	16						

For designs that require both a multiplied and non-multiplied clock, the clock trace on the board can be connected to the GCLK1 pin. In the Altera software, the GCLK1 pin can feed both the ClockLock and ClockBoost circuitry in the ACEX 1K device. However, when both circuits are used, the other clock pin cannot be used.

# ClockLock & ClockBoost Timing Parameters

For the ClockLock and ClockBoost circuitry to function properly, the incoming clock must meet certain requirements. If these specifications are not met, the circuitry may not lock onto the incoming clock, which generates an erroneous clock within the device. The clock generated by the ClockLock and ClockBoost circuitry must also meet certain specifications. If the incoming clock meets these requirements during configuration, the ClockLock and ClockBoost circuitry will lock onto the clock during configuration. The circuit will be ready for use immediately after configuration. Figure 19 shows the incoming and generated clock specifications.

Figure 19. Specifications for the Incoming & Generated Clocks Note (1)



#### Note:

(1) The  $\mathbf{t_I}$  parameter refers to the nominal input clock period; the  $\mathbf{t_O}$  parameter refers to the nominal output clock period.

Table 12.	ClockLock & ClockBoost Parameters for -2	? Speed-Grade De	vices			
Symbol	Parameter	Condition	Min	Тур	Max	Unit
$t_R$	Input rise time				5	ns
$t_{\digamma}$	Input fall time				5	ns
t <sub>INDUTY</sub>	Input duty cycle		40		60	%
f <sub>CLK1</sub>	Input clock frequency (ClockBoost clock multiplication factor equals 1)		25		80	MHz
f <sub>CLK2</sub>	Input clock frequency (ClockBoost clock multiplication factor equals 2)		16		40	MHz
f <sub>CLKDEV</sub>	Input deviation from user specification in the software (1)				25,000	PPM
t <sub>INCLKSTB</sub>	Input clock stability (measured between adjacent clocks)				100	ps
t <sub>LOCK</sub>	Time required for ClockLock or ClockBoost to acquire lock (3)				10	μs
t <sub>JITTER</sub>	Jitter on ClockLock or ClockBoost-	$t_{INCLKSTB}$ < 100			250 <i>(4)</i>	ps
	generated clock (4)	t <sub>INCLKSTB</sub> < 50			200 (4)	ps
toutduty	Duty cycle for ClockLock or ClockBoost- generated clock		40	50	60	%

#### Notes to tables:

- (1) To implement the ClockLock and ClockBoost circuitry with the Altera software, designers must specify the input frequency. The Altera software tunes the PLL in the ClockLock and ClockBoost circuitry to this frequency. The f<sub>CLKDEV</sub> parameter specifies how much the incoming clock can differ from the specified frequency during device operation. Simulation does not reflect this parameter.
- (2) Twenty-five thousand parts per million (PPM) equates to 2.5% of input clock period.
- (3) During device configuration, the ClockLock and ClockBoost circuitry is configured before the rest of the device. If the incoming clock is supplied during configuration, the ClockLock and ClockBoost circuitry locks during configuration because the  $t_{LOCK}$  value is less than the time required for configuration.
- (4) The  $t_{IITTER}$  specification is measured under long-term observation. The maximum value for  $t_{IITTER}$  is 200 ps if  $t_{INCLKSTB}$  is lower than 50 ps.

# I/O Configuration

This section discusses the PCI pull-up clamping diode option, slew-rate control, open-drain output option, and MultiVolt I/O interface for ACEX 1K devices. The PCI pull-up clamping diode, slew-rate control, and open-drain output options are controlled pin-by-pin via Altera software logic options. The MultiVolt I/O interface is controlled by connecting  $V_{\rm CCIO}$  to a different voltage than  $V_{\rm CCINT}$ . Its effect can be simulated in the Altera software via the **Global Project Device Options** dialog box (Assign menu).

Table 2	1. ACEX 1K Device Capacitan	ce Note (14)			
Symbol	Parameter	Conditions	Min	Max	Unit
C <sub>IN</sub>	Input capacitance	V <sub>IN</sub> = 0 V, f = 1.0 MHz		10	pF
C <sub>INCLK</sub>	Input capacitance on dedicated clock pin	V <sub>IN</sub> = 0 V, f = 1.0 MHz		12	pF
C <sub>OUT</sub>	Output capacitance	V <sub>OUT</sub> = 0 V, f = 1.0 MHz		10	pF

#### Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage is -0.5 V. During transitions, the inputs may undershoot to -2.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial- and extended-temperature-range devices.
- (4) Maximum  $V_{CC}$  rise time is 100 ms, and  $V_{CC}$  must rise monotonically.
- (5) All pins, including dedicated inputs, clock, I/O, and JTAG pins, may be driven before V<sub>CCINT</sub> and V<sub>CCIO</sub> are powered.
- (6) Typical values are for  $T_A = 25^{\circ}$  C,  $V_{CCINT} = 2.5$  V, and  $V_{CCIO} = 2.5$  V or 3.3 V.
- (7) These values are specified under the ACEX 1K Recommended Operating Conditions shown in Table 19 on page 46.
- (8) The ACEX 1K input buffers are compatible with 2.5-V, 3.3-V (LVTTL and LVCMOS), and 5.0-V TTL and CMOS signals. Additionally, the input buffers are 3.3-V PCI compliant when V<sub>CCIO</sub> and V<sub>CCINT</sub> meet the relationship shown in Figure 22.
- The I<sub>OH</sub> parameter refers to high-level TTL, PCI, or CMOS output current.
- (10) The  $I_{OL}$  parameter refers to low-level TTL, PCI, or CMOS output current. This parameter applies to open-drain pins as well as output pins.
- (11) This value is specified for normal device operation. The value may vary during power-up.
- (12) This parameter applies to -1 speed grade commercial temperature devices and -2 speed grade industrial and extended temperature devices.
- (13) Pin pull-up resistance values will be lower if the pin is driven higher than V<sub>CCIO</sub> by an external source.
- (14) Capacitance is sample-tested only.

Figure 22 shows the required relationship between  $V_{CCIO}$  and  $V_{CCINT}$  to satisfy 3.3-V PCI compliance.

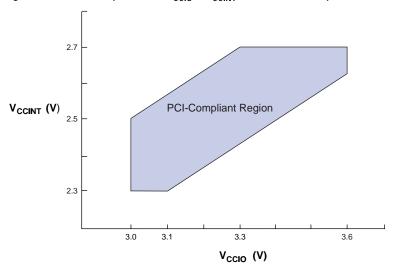


Figure 22. Relationship between V<sub>CCIO</sub> & V<sub>CCINT</sub> for 3.3-V PCI Compliance

Figure 23 shows the typical output drive characteristics of ACEX 1K devices with 3.3-V and 2.5-V  $V_{\rm CCIO}$ . The output driver is compliant to the 3.3-V *PCI Local Bus Specification, Revision 2.2* (when VCCIO pins are connected to 3.3 V). ACEX 1K devices with a -1 speed grade also comply with the drive strength requirements of the *PCI Local Bus Specification, Revision 2.2* (when VCCINT pins are powered with a minimum supply of 2.375 V, and VCCIO pins are connected to 3.3 V). Therefore, these devices can be used in open 5.0-V PCI systems.

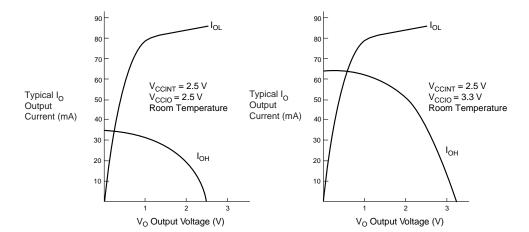


Figure 23. Output Drive Characteristics of ACEX 1K Devices

# **Timing Model**

The continuous, high-performance FastTrack Interconnect routing resources ensure accurate simulation and timing analysis as well as predictable performance. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and, therefore, have an unpredictable performance.

Device performance can be estimated by following the signal path from a source, through the interconnect, to the destination. For example, the registered performance between two LEs on the same row can be calculated by adding the following parameters:

- LE register clock-to-output delay  $(t_{CO})$
- Interconnect delay ( $t_{SAMEROW}$ )
- LE look-up table delay ( $t_{LUT}$ )
- LE register setup time  $(t_{SI})$

The routing delay depends on the placement of the source and destination LEs. A more complex registered path may involve multiple combinatorial LEs between the source and destination LEs.

Timing simulation and delay prediction are available with the simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time analysis, and device-wide performance analysis.

Tables 30 through 36 show EP1K10 device internal and external timing parameters.

Symbol	Speed Grade								
	-1		-2		-3				
	Min	Max	Min	Max	Min	Max			
$t_{LUT}$		0.7		0.8		1.1	ns		
t <sub>CLUT</sub>		0.5		0.6		0.8	ns		
t <sub>RLUT</sub>		0.6		0.7		1.0	ns		
t <sub>PACKED</sub>		0.4		0.4		0.5	ns		
t <sub>EN</sub>		0.9		1.0		1.3	ns		
t <sub>CICO</sub>		0.1		0.1		0.2	ns		
t <sub>CGEN</sub>		0.4		0.5		0.7	ns		
t <sub>CGENR</sub>		0.1		0.1		0.2	ns		
t <sub>CASC</sub>		0.7		0.9		1.1	ns		
$t_C$		1.1		1.3		1.7	ns		
$t_{CO}$		0.5		0.7		0.9	ns		
t <sub>COMB</sub>		0.4		0.5		0.7	ns		
t <sub>SU</sub>	0.7		0.8		1.0		ns		
t <sub>H</sub>	0.9		1.0		1.1		ns		
t <sub>PRE</sub>		0.8		1.0		1.4	ns		
t <sub>CLR</sub>		0.9		1.0		1.4	ns		
t <sub>CH</sub>	2.0		2.5		2.5		ns		
$t_{CL}$	2.0		2.5		2.5		ns		

Symbol		Speed Grade								
	-1		-2		-	3				
	Min	Max	Min	Max	Min	Max				
t <sub>DIN2IOE</sub>		2.3		2.7		3.6	ns			
t <sub>DIN2LE</sub>		0.8		1.1		1.4	ns			
t <sub>DIN2DATA</sub>		1.1		1.4		1.8	ns			
t <sub>DCLK2IOE</sub>		2.3		2.7		3.6	ns			
t <sub>DCLK2LE</sub>		0.8		1.1		1.4	ns			
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns			
t <sub>SAMEROW</sub>		1.8		2.1		2.9	ns			
t <sub>SAME</sub> COLUMN		0.3		0.4		0.7	ns			
t <sub>DIFFROW</sub>		2.1		2.5		3.6	ns			
t <sub>TWOROWS</sub>		3.9		4.6		6.5	ns			
t <sub>LEPERIPH</sub>		3.3		3.7		4.8	ns			
t <sub>LABCARRY</sub>		0.3		0.4		0.5	ns			
t <sub>LABCASC</sub>		0.9		1.0		1.4	ns			

Table 35. EP1K10	External Til	ming Param	eters No	te (1)			
Symbol		Unit					
	-1		-	-2		3	
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		7.5		9.5		12.5	ns
t <sub>INSU</sub> (2), (3)	2.4		2.7		3.6		ns
t <sub>INH</sub> (2), (3)	0.0		0.0		0.0		ns
t <sub>оитсо</sub> (2), (3)	2.0	6.6	2.0	7.8	2.0	9.6	ns
t <sub>INSU</sub> (4), (3)	1.4		1.7		-		ns
t <sub>INH</sub> (4), (3)	0.5	5.1	0.5	6.4	_	_	ns
t <sub>оитсо</sub> (4), (3)	0.0		0.0		-		ns
t <sub>PCISU</sub> (3)	3.0		4.2		6.4		ns
t <sub>PCIH</sub> (3)	0.0		0.0		_		ns
t <sub>PCICO</sub> (3)	2.0	6.0	2.0	7.5	2.0	10.2	ns

Symbol	Speed Grade								
	-1		-	-2		3			
	Min	Max	Min	Max	Min	Max			
t <sub>INSUBIDIR</sub> (2)	2.2		2.3		3.2		ns		
t <sub>INHBIDIR</sub> (2)	0.0		0.0		0.0		ns		
t <sub>OUTCOBIDIR</sub> (2)	2.0	6.6	2.0	7.8	2.0	9.6	ns		
t <sub>XZBIDIR</sub> (2)		8.8		11.2		14.0	ns		
t <sub>ZXBIDIR</sub> (2)		8.8		11.2		14.0	ns		
t <sub>INSUBIDIR</sub> (4)	3.1		3.3		-	-			
t <sub>INHBIDIR</sub> (4)	0.0		0.0		-				
toutcobidir (4)	0.5	5.1	0.5	6.4	-	-	ns		
t <sub>XZBIDIR</sub> (4)		7.3		9.2		-	ns		
t <sub>ZXBIDIR</sub> (4)		7.3		9.2		-	ns		

## Notes to tables:

- (1) All timing parameters are described in Tables 22 through 29 in this data sheet.
- (2) This parameter is measured without the use of the ClockLock or ClockBoost circuits.
- (3) These parameters are specified by characterization.
- (4) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

Tables 37 through 43 show EP1K30 device internal and external timing parameters.

Symbol		Speed Grade							
	-1		-2		-	3			
	Min	Max	Min	Max	Min	Max			
$t_{LUT}$		0.7		0.8		1.1	ns		
t <sub>CLUT</sub>		0.5		0.6		0.8	ns		
t <sub>RLUT</sub>		0.6		0.7		1.0	ns		
t <sub>PACKED</sub>		0.3		0.4		0.5	ns		
$t_{EN}$		0.6		0.8		1.0	ns		
t <sub>CICO</sub>		0.1		0.1		0.2	ns		
t <sub>CGEN</sub>		0.4		0.5		0.7	ns		
t <sub>CGENR</sub>		0.1		0.1		0.2	ns		
t <sub>CASC</sub>		0.6		0.8		1.0	ns		
t <sub>C</sub>		0.0		0.0		0.0	ns		
t <sub>co</sub>		0.3		0.4		0.5	ns		

Symbol	Speed Grade								
	-1		-2		-3				
	Min	Max	Min	Max	Min	Max			
t <sub>EABDATA1</sub>		1.7		2.0		2.3	ns		
t <sub>EABDATA1</sub>		0.6		0.7		0.8	ns		
t <sub>EABWE1</sub>		1.1		1.3		1.4	ns		
t <sub>EABWE2</sub>		0.4		0.4		0.5	ns		
t <sub>EABRE1</sub>		0.8		0.9		1.0	ns		
t <sub>EABRE2</sub>		0.4		0.4		0.5	ns		
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns		
t <sub>EABCO</sub>		0.3		0.3		0.4	ns		
t <sub>EABBYPASS</sub>		0.5		0.6		0.7	ns		
t <sub>EABSU</sub>	0.9		1.0		1.2		ns		
t <sub>EABH</sub>	0.4		0.4		0.5		ns		
t <sub>EABCLR</sub>	0.3		0.3		0.3		ns		
$t_{AA}$		3.2		3.8		4.4	ns		
$t_{WP}$	2.5		2.9		3.3		ns		
t <sub>RP</sub>	0.9		1.1		1.2		ns		
t <sub>WDSU</sub>	0.9		1.0		1.1		ns		
t <sub>WDH</sub>	0.1		0.1		0.1		ns		
t <sub>WASU</sub>	1.7	-	2.0	-	2.3		ns		
t <sub>WAH</sub>	1.8		2.1		2.4		ns		
t <sub>RASU</sub>	3.1		3.7		4.2		ns		
t <sub>RAH</sub>	0.2		0.2		0.2		ns		
$t_{WO}$		2.5		2.9		3.3	ns		
t <sub>DD</sub>		2.5		2.9		3.3	ns		
t <sub>EABOUT</sub>		0.5		0.6		0.7	ns		
t <sub>EABCH</sub>	1.5		2.0		2.3		ns		
t <sub>EABCL</sub>	2.5		2.9		3.3		ns		

Symbol	Speed Grade								
	-1		-	-2		3			
	Min	Max	Min	Max	Min	Max			
t <sub>EABAA</sub>		5.9		7.6		9.9	ns		
t <sub>EABRCOMB</sub>	5.9		7.6		9.9		ns		
t <sub>EABRCREG</sub>	5.1		6.5		8.5		ns		
t <sub>EABWP</sub>	2.7		3.5		4.7		ns		
t <sub>EABWCOMB</sub>	5.9		7.7		10.3		ns		
t <sub>EABWCREG</sub>	5.4		7.0		9.4		ns		
t <sub>EABDD</sub>		3.4		4.5		5.9	ns		
t <sub>EABDATA</sub> CO		0.5		0.7		0.8	ns		
t <sub>EABDATASU</sub>	0.8		1.0		1.4		ns		
t <sub>EABDATAH</sub>	0.1		0.1		0.2		ns		
t <sub>EABWESU</sub>	1.1		1.4		1.9		ns		
t <sub>EABWEH</sub>	0.0		0.0		0.0		ns		
t <sub>EABWDSU</sub>	1.0		1.3		1.7		ns		
t <sub>EABWDH</sub>	0.2		0.2		0.3		ns		
t <sub>EABWASU</sub>	4.1		5.2		6.8		ns		
t <sub>EABWAH</sub>	0.0		0.0		0.0		ns		
t <sub>EABWO</sub>		3.4		4.5		5.9	ns		

# Revision History

The information contained in the *ACEX 1K Programmable Logic Device Family Data Sheet* version 3.4 supersedes information published in previous versions.

The following changes were made to the *ACEX 1K Programmable Logic Device Family Data Sheet* version 3.4: added extended temperature support.